



NCE N-Channel Super Trench Power MOSFET

Description

The NCEP01T11D uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

- V_{DS} =100V,I_D =108A
 R_{DS(ON)}=5.7mΩ (typical) @ V_{GS}=10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED! 100% ΔVds TESTED!

(1) G (3) S Schematic diagram NCEPOITTID XXXXX Marking and pin assignment

(2) D



TO-263-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP01T11D	NCEP01T11D	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous (Silicon Limited)	Ι _D	108	А
Drain Current-Continuous (Package Limited)	I _D	108	А
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	78	А
Pulsed Drain Current	I _{DM}	380	А
Maximum Power Dissipation	PD	160	W
Derating factor		1.1	W/℃
Single pulse avalanche energy ^(Note 5)	E _{AS}	676	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C







Thermal Characteristic

Electrical Characteristics (T_C=25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	on Min		Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	100		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	····		•	•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.5	-	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I_{D} =50A	-	5.7	6.5	mΩ
Forward Transconductance	g fs	V _{DS} =10V,I _D =50A	40	-	-	S
Dynamic Characteristics (Note4)					•	•
Input Capacitance	Clss		-	4300	-	PF
Output Capacitance	C _{oss}	V _{DS} =50V,V _{GS} =0V, F=1.0MHz	-	790	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0WHZ	-	47	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	13	-	nS
Turn-on Rise Time	tr	V _{DD} =50V,I _D =50A	-	58	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =4.7 Ω	_	39	-	nS
Turn-Off Fall Time	t _f		_	8	-	nS
Total Gate Charge	Qg	V 50V/L 50A	-	60		nC
Gate-Source Charge	Q _{gs}	V_{DS} =50V,I _D =50A,	_	21		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	11		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =108A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	108	Α
Reverse Recovery Time	t _{rr}	T_J = 25°C, I_F = I_S	-	60		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	140		nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^\circ\!\mathrm{C}$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25 Ω

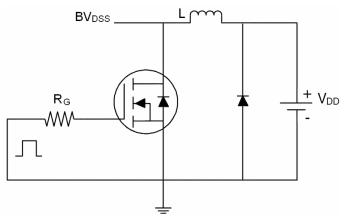


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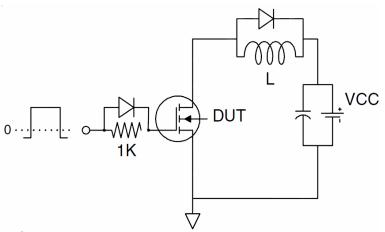
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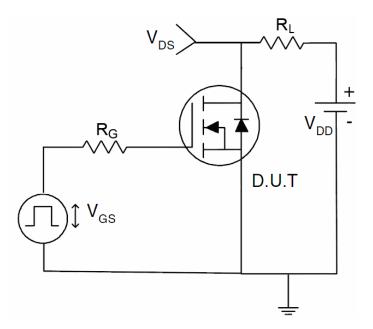
Test Circuit 1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit

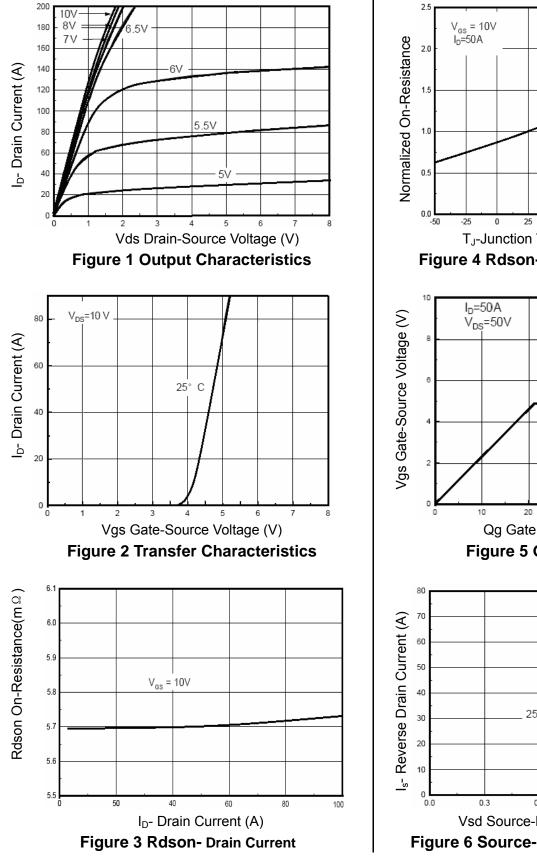


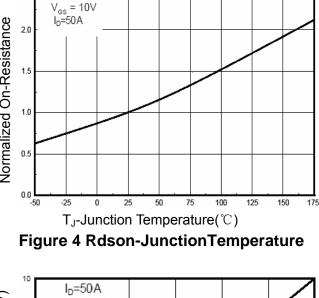


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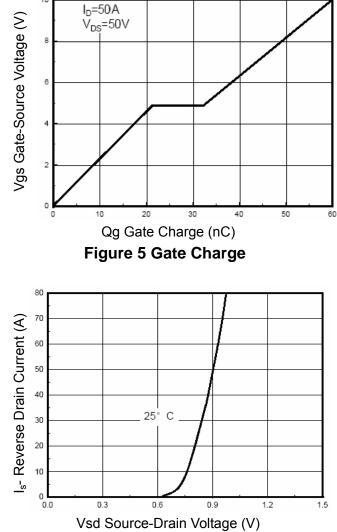


Figure 6 Source- Drain Diode Forward



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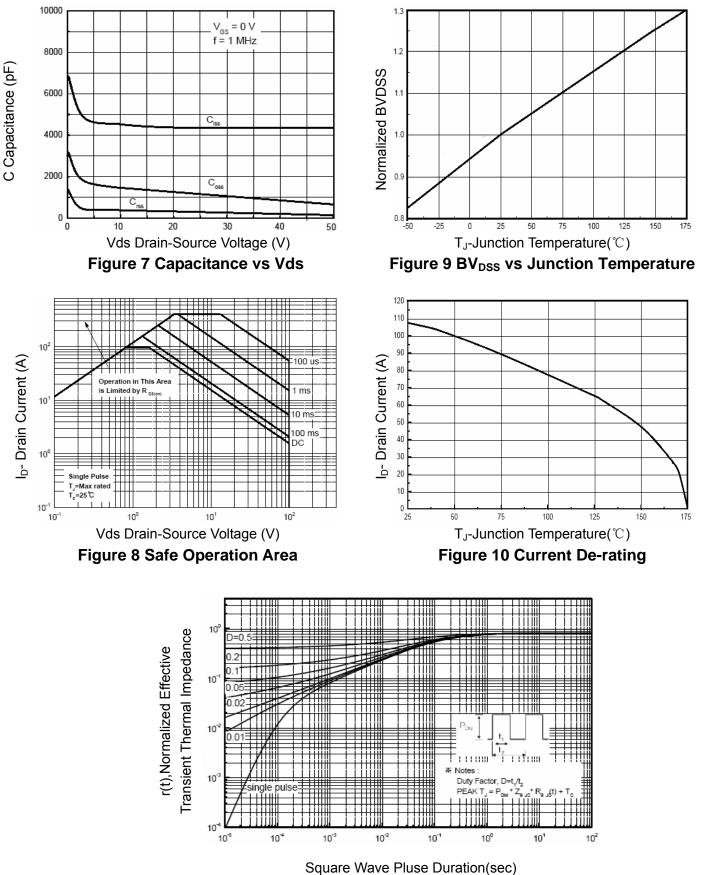
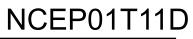


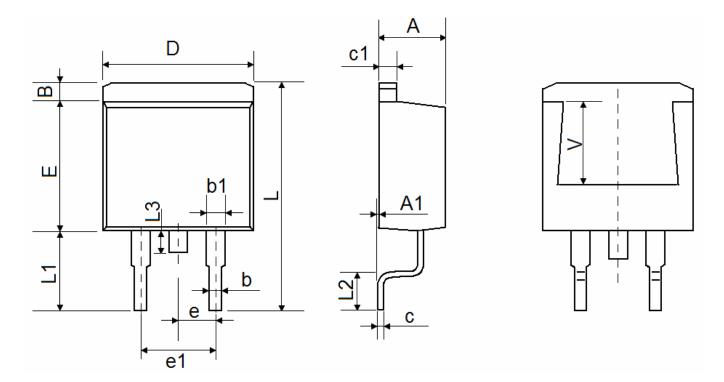
Figure 11 Normalized Maximum Transient Thermal Impedance



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TO-263-2L Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600 REF		0.220 REF		







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